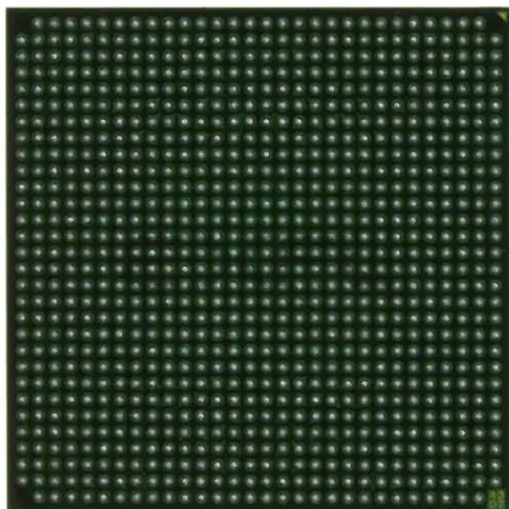




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1920
Number of Logic Elements/Cells	-
Total RAM Bits	884736
Number of I/O	528
Number of Gates	1500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	896-BBGA, FCBGA
Supplier Device Package	896-FCBGA (31x31)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v1500-5ff896i

Table 13: Virtex-II Logic Resources Available in All CLBs

Device	CLB Array: Row x Column	Number of Slices	Number of LUTs	Max Distributed SelectRAM or Shift Register (bits)	Number of Flip-Flops	Number of Carry-Chains ⁽¹⁾	Number of SOP Chains ⁽¹⁾
XC2V40	8 x 8	256	512	8,192	512	16	16
XC2V80	16 x 8	512	1,024	16,384	1,024	16	32
XC2V250	24 x 16	1,536	3,072	49,152	3,072	32	48
XC2V500	32 x 24	3,072	6,144	98,304	6,144	48	64
XC2V1000	40 x 32	5,120	10,240	163,840	10,240	64	80
XC2V1500	48 x 40	7,680	15,360	245,760	15,360	80	96
XC2V2000	56 x 48	10,752	21,504	344,064	21,504	96	112
XC2V3000	64 x 56	14,336	28,672	458,752	28,672	112	128
XC2V4000	80 x 72	23,040	46,080	737,280	46,080	144	160
XC2V6000	96 x 88	33,792	67,584	1,081,344	67,584	176	192
XC2V8000	112 x 104	46,592	93,184	1,490,944	93,184	208	224

Notes:

1. The carry-chains and SOP chains can be split or cascaded.

18 Kbit Block SelectRAM Resources

Introduction

Virtex-II devices incorporate large amounts of 18 Kbit block SelectRAM. These complement the distributed SelectRAM resources that provide shallow RAM structures implemented in CLBs. Each Virtex-II block SelectRAM is an 18 Kbit true dual-port RAM with two independently clocked and independently controlled synchronous ports that access a common storage area. Both ports are functionally identical. CLK, EN, WE, and SSR polarities are defined through configuration.

Each port has the following types of inputs: Clock and Clock Enable, Write Enable, Set/Reset, and Address, as well as separate Data/parity data inputs (for write) and Data/parity data outputs (for read).

Operation is synchronous; the block SelectRAM behaves like a register. Control, address and data inputs must (and need only) be valid during the set-up time window prior to a rising (or falling, a configuration option) clock edge. Data outputs change as a result of the same clock edge.

Configuration

The Virtex-II block SelectRAM supports various configurations, including single- and dual-port RAM and various

data/address aspect ratios. Supported memory configurations for single- and dual-port modes are shown in Table 14.

Table 14: Dual- and Single-Port Configurations

16K x 1 bit	2K x 9 bits
8K x 2 bits	1K x 18 bits
4K x 4 bits	512 x 36 bits

Single-Port Configuration

As a single-port RAM, the block SelectRAM has access to the 18 Kbit memory locations in any of the 2K x 9-bit, 1K x 18-bit, or 512 x 36-bit configurations and to 16 Kbit memory locations in any of the 16K x 1-bit, 8K x 2-bit, or 4K x 4-bit configurations. The advantage of the 9-bit, 18-bit and 36-bit widths is the ability to store a parity bit for each eight bits. Parity bits must be generated or checked externally in user logic. In such cases, the width is viewed as 8 + 1, 16 + 2, or 32 + 4. These extra parity bits are stored and behave exactly as the other bits, including the timing parameters. Video applications can use the 9-bit ratio of Virtex-II block SelectRAM memory to advantage.

Each block SelectRAM cell is a fully synchronous memory as illustrated in Figure 29. Input data bus and output data bus widths are identical.

IOB Input Switching Characteristics Standard Adjustments

Table 15 gives all standard-specific data input delay adjustments.

Table 15: IOB Input Switching Characteristics Standard Adjustments

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVTTL (Low-Voltage Transistor-Transistor Logic)	LVTTL	T_{ILVTTL}	0.00	0.00	0.00	ns
LVC MOS (Low-Voltage CMOS), 3.3V	LVC MOS33	$T_{ILVC MOS33}$	0.00	0.00	0.00	ns
LVC MOS, 2.5V	LVC MOS25	$T_{ILVC MOS25}$	0.11	0.11	0.12	ns
LVC MOS, 1.8V	LVC MOS18	$T_{ILVC MOS18}$	0.42	0.43	0.49	ns
LVC MOS, 1.5V	LVC MOS15	$T_{ILVC MOS15}$	0.98	1.00	1.15	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T_{ILVDS_25}	0.60	0.60	0.69	ns
LVDS, 3.3V	LVDS_33	T_{ILVDS_33}	0.60	0.60	0.69	ns
LVDSEXT (Extended Mode), 2.5V	LVDSEXT_25	$T_{ILVDSEXT_25}$	0.68	0.69	0.79	ns
LVDSEXT, 3.3V	LVDSEXT_33	$T_{ILVDSEXT_33}$	0.56	0.56	0.65	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T_{IULVDS_25}	0.48	0.49	0.56	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T_{IBLVDS_25}	0.68	0.69	0.79	ns
LDT (HyperTransport), 2.5V	LDT_25	$T_{ILD T_25}$	0.48	0.49	0.56	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	$T_{ILVPECL_33}$	0.60	0.60	0.69	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T_{IPCI33_3}	0.00	0.00	0.00	ns
PCI, 66 MHz, 3.3V	PCI66_3	T_{IPCI66_3}	0.00	0.00	0.00	ns
PCI-X, 133 MHz, 3.3V	PCIX	$T_{IPCI X}$	0.00	0.00	0.00	ns
GTL (Gunning Transceiver Logic)	GTL	T_{IGTL}	0.42	0.42	0.48	ns
GTL Plus	GTLP	T_{IGTLP}	0.42	0.42	0.48	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T_{IHSTL_I}	0.42	0.42	0.48	ns
HSTL, Class II	HSTL_II	T_{IHSTL_II}	0.42	0.42	0.48	ns
HSTL, Class III	HSTL_III	T_{IHSTL_III}	0.42	0.42	0.48	ns
HSTL, Class IV	HSTL_IV	T_{IHSTL_IV}	0.42	0.42	0.48	ns
HSTL, Class I, 1.8V	HSTL_I_18	$T_{IHSTL_I_18}$	0.42	0.42	0.48	ns
HSTL, Class II, 1.8V	HSTL_II_18	$T_{IHSTL_II_18}$	0.42	0.42	0.48	ns
HSTL, Class III, 1.8V	HSTL_III_18	$T_{IHSTL_III_18}$	0.42	0.42	0.48	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	$T_{IHSTL_IV_18}$	0.42	0.42	0.48	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	$T_{ISSTL18_I}$	0.42	0.42	0.48	ns
SSTL, Class II, 1.8V	SSTL18_II	$T_{ISSTL18_II}$	0.42	0.42	0.48	ns
SSTL, Class I, 2.5V	SSTL2_I	T_{ISSTL2_I}	0.42	0.42	0.48	ns
SSTL, Class II, 2.5V	SSTL2_II	T_{ISSTL2_II}	0.42	0.42	0.48	ns
SSTL, Class I, 3.3V	SSTL3_I	T_{ISSTL3_I}	0.35	0.35	0.40	ns
SSTL, Class II, 3.3V	SSTL3_II	T_{ISSTL3_II}	0.35	0.35	0.40	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	T_{IAGP}	0.35	0.35	0.40	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T_{ILVDCI_33}	0.00	0.00	0.00	ns
LVDCI, 2.5V	LVDCI_25	T_{ILVDCI_25}	0.11	0.11	0.12	ns
LVDCI, 1.8V	LVDCI_18	T_{ILVDCI_18}	0.42	0.43	0.49	ns
LVDCI, 1.5V	LVDCI_15	T_{ILVDCI_15}	0.98	1.00	1.14	ns

Global Clock Setup and Hold for LVTTL Standard, *Without DCM*

Table 37: Global Clock Setup and Hold for LVTTL Standard, *Without DCM*

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVTTL Standard. ⁽²⁾ For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11 .						
Full Delay Global Clock and IFF ⁽¹⁾ without DCM	T _{PSFD} /T _{PHFD}	XC2V40	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V80	2.10/ 0.00	2.10/ 0.00	2.21/ 0.00	ns
		XC2V250	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V500	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V1000	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V1500	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V2000	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V3000	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V4000	2.00/ 0.00	2.00/ 0.00	2.30/ 0.00	ns
		XC2V6000	1.92/ 0.50	1.92/ 0.50	2.21/ 0.50	ns
		XC2V8000		2.38/ 0.00	2.60/ 0.00	ns

Notes:

1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.
3. These values are parametrically measured.

Pin Definitions

Table 4 provides a description of each pin type listed in Virtex-II pinout tables.

Table 4: Virtex-II Pin Definitions

Pin Name	Direction	Description
User I/O Pins		
IO_LXXY_#	Input/Output/ Bidirectional	All user I/O pins are capable of differential signalling and can implement LVDS, ULVDS, BLVDS, LVPECL, or LDT pairs. Each user I/O is labeled “IO_LXXY_#”, where: IO indicates a user I/O pin. LXXY indicates a differential pair, with XX a unique pair in the bank and Y = P/N for the positive and negative sides of the differential pair. # indicates the bank number (0 through 7)
Dual-Function Pins		
IO_LXXY_#/ZZZ		The dual-function pins are labelled “IO_LXXY_#/ZZZ”, where ZZZ can be one of the following pins: Per Bank - VRP , VRN , or VREF Globally - GCLKX(S/P) , BUSY/DOUT , INIT_B , D0/DIN – D7 , RDWR_B , or CS_B
With /ZZZ:		
D0/DIN, D1, D2, D3, D4, D5, D6, D7	Input/Output	<i>In SelectMAP mode</i>, D0 through D7 are configuration data pins. These pins become user I/Os after configuration, unless the SelectMAP port is retained. <i>In bit-serial modes</i>, DIN (D0) is the single-data input. This pin becomes a user I/O after configuration.
CS_B	Input	In SelectMAP mode, this is the active-low Chip Select signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
RDWR_B	Input	In SelectMAP mode, this is the active-low Write Enable signal. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained.
BUSY/DOUT	Output	<i>In SelectMAP mode</i>, BUSY controls the rate at which configuration data is loaded. The pin becomes a user I/O after configuration, unless the SelectMAP port is retained. <i>In bit-serial modes</i>, DOUT provides preamble and configuration data to downstream devices in a daisy-chain. The pin becomes a user I/O after configuration.
INIT_B	Bidirectional (open-drain)	When Low, this pin indicates that the configuration memory is being cleared. When held Low, the start of configuration is delayed. During configuration, a Low on this output indicates that a configuration data error has occurred. The pin becomes a user I/O after configuration.
GCLKx (S/P)	Input/Output	These are clock input pins that connect to Global Clock Buffers. These pins become regular user I/Os when not needed for clocks.
VRP	Input	This pin is for the DCI voltage reference resistor of P transistor (per bank).
VRN	Input	This pin is for the DCI voltage reference resistor of N transistor (per bank).
ALT_VRP	Input	This is the alternative pin for the DCI voltage reference resistor of P transistor.
ALT_VRN	Input	This is the alternative pin for the DCI voltage reference resistor of N transistor.
V _{REF}	Input	These are input threshold voltage pins. They become user I/Os when an external threshold voltage is not needed (per bank).
Dedicated Pins⁽¹⁾		
CCLK	Input/Output	Configuration clock. Output in Master mode or Input in Slave mode.

Table 4: Virtex-II Pin Definitions (Continued)

Pin Name	Direction	Description
PROG_B	Input	Active Low asynchronous reset to configuration logic. This pin has a permanent weak pull-up resistor.
DONE	Input/Output	DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, this pin indicates completion of the configuration process. As an input, a Low level on DONE can be configured to delay the start-up sequence.
M2, M1, M0	Input	Configuration mode selection.
HSWAP_EN	Input	Enable I/O pull-ups during configuration.
TCK	Input	Boundary Scan Clock.
TDI	Input	Boundary Scan Data Input.
TDO	Output	Boundary Scan Data Output.
TMS	Input	Boundary Scan Mode Select.
PWRDWN_B	Input (unsupported)	Active Low power-down pin (unsupported). <i>Driving this pin Low can adversely affect device operation and configuration.</i> PWRDWN_B is internally pulled High, which is its default state. It does not require an external pull-up.
Other Pins		
DXN, DXP	N/A	Temperature-sensing diode pins (Anode: DXP, Cathode: DXN).
V _{BATT}	Input	Decryptor key memory backup supply. Connect V _{BATT} to V _{CCAUX} or GND if battery is not used.
RSVD	N/A	Reserved pin - do not connect.
V _{CCO}	Input	Power-supply pins for the output drivers (per bank).
V _{CCAUX}	Input	Power-supply pins for auxiliary circuits.
V _{CCINT}	Input	Power-supply pins for the internal core logic.
GND	Input	Ground.

Notes:

1. All dedicated pins (JTAG and configuration) are powered by V_{CCAUX} (independent of the bank V_{CCO} voltage).

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
2	IO_L45N_2	H19		
2	IO_L45P_2/VREF_2	H20		
2	IO_L46N_2	H21		
2	IO_L46P_2	H22		
2	IO_L48N_2	J17		
2	IO_L48P_2	J18		
2	IO_L49N_2	J19	NC	
2	IO_L49P_2	J20	NC	
2	IO_L51N_2	J21	NC	
2	IO_L51P_2/VREF_2	J22	NC	
2	IO_L52N_2	K17	NC	
2	IO_L52P_2	K18	NC	
2	IO_L54N_2	K19	NC	
2	IO_L54P_2	K20	NC	
2	IO_L91N_2	K21		
2	IO_L91P_2	K22		
2	IO_L93N_2	L17		
2	IO_L93P_2/VREF_2	L18		
2	IO_L94N_2	L19		
2	IO_L94P_2	L20		
2	IO_L96N_2	L21		
2	IO_L96P_2	L22		
3	IO_L96N_3	M21		
3	IO_L96P_3	M20		
3	IO_L94N_3	M19		
3	IO_L94P_3	M18		
3	IO_L93N_3/VREF_3	M17		
3	IO_L93P_3	N17		
3	IO_L91N_3	N22		
3	IO_L91P_3	N21		
3	IO_L54N_3	N20	NC	
3	IO_L54P_3	N19	NC	
3	IO_L52N_3	N18	NC	

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
6	IO_L46P_6	R2		
6	IO_L46N_6	R1		
6	IO_L48P_6	P6		
6	IO_L48N_6	P5		
6	IO_L49P_6	P4	NC	
6	IO_L49N_6	P3	NC	
6	IO_L51P_6	P2	NC	
6	IO_L51N_6/VREF_6	P1	NC	
6	IO_L52P_6	N6	NC	
6	IO_L52N_6	N5	NC	
6	IO_L54P_6	N4	NC	
6	IO_L54N_6	N3	NC	
6	IO_L91P_6	N2		
6	IO_L91N_6	N1		
6	IO_L93P_6	M6		
6	IO_L93N_6/VREF_6	M5		
6	IO_L94P_6	M4		
6	IO_L94N_6	M3		
6	IO_L96P_6	M2		
6	IO_L96N_6	M1		
7	IO_L96P_7	L2		
7	IO_L96N_7	L3		
7	IO_L94P_7	L4		
7	IO_L94N_7	L5		
7	IO_L93P_7/VREF_7	K1		
7	IO_L93N_7	K2		
7	IO_L91P_7	K3		
7	IO_L91N_7	K4		
7	IO_L54P_7	L6	NC	
7	IO_L54N_7	K6	NC	
7	IO_L52P_7	K5	NC	
7	IO_L52N_7	J5	NC	
7	IO_L51P_7/VREF_7	J1	NC	

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
7	VCCO_7	H6		
7	VCCO_7	G6		
NA	CCLK	Y19		
NA	PROG_B	A2		
NA	DONE	AB20		
NA	M0	AB2		
NA	M1	W3		
NA	M2	AB3		
NA	HSWAP_EN	B3		
NA	TCK	C19		
NA	TDI	D3		
NA	TDO	D20		
NA	TMS	B20		
NA	PWRDWN_B	AB21		
NA	DXN	D5		
NA	DXP	A3		
NA	VBATT	A21		
NA	RSVD	A20		
NA	VCCAUX	AB11		
NA	VCCAUX	AA22		
NA	VCCAUX	AA1		
NA	VCCAUX	M22		
NA	VCCAUX	L1		
NA	VCCAUX	B22		
NA	VCCAUX	B1		
NA	VCCAUX	A12		
NA	VCCINT	U17		
NA	VCCINT	U6		
NA	VCCINT	T16		
NA	VCCINT	T15		
NA	VCCINT	T8		
NA	VCCINT	T7		

BG728/BGG728 Standard BGA Package

As shown in Table 10, XC2V3000 Virtex-II devices are available in the BG728/BGG728 BGA package. Following this table are the **BG728/BGG728 Standard BGA Package Specifications (1.27mm pitch)**.

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
0	IO_L01N_0	B3
0	IO_L01P_0	A3
0	IO_L02N_0	B4
0	IO_L02P_0	A4
0	IO_L03N_0/VRP_0	C5
0	IO_L03P_0/VRN_0	C6
0	IO_L04N_0/VREF_0	B5
0	IO_L04P_0	A5
0	IO_L05N_0	E6
0	IO_L05P_0	D6
0	IO_L06N_0	B6
0	IO_L06P_0	A6
0	IO_L19N_0	E7
0	IO_L19P_0	D8
0	IO_L21N_0	F8
0	IO_L21P_0/VREF_0	E8
0	IO_L22N_0	C7
0	IO_L22P_0	C8
0	IO_L24N_0	B7
0	IO_L24P_0	A7
0	IO_L25N_0	H9
0	IO_L25P_0	J9
0	IO_L27N_0	F9
0	IO_L27P_0/VREF_0	G9
0	IO_L28N_0	E9
0	IO_L28P_0	D9
0	IO_L30N_0	C9
0	IO_L30P_0	B9
0	IO_L49N_0	A8
0	IO_L49P_0	A9
0	IO_L51N_0	G10
0	IO_L51P_0/VREF_0	H10
0	IO_L52N_0	F10

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
NA	VCCAUX	P26
NA	VCCAUX	P2
NA	VCCAUX	C26
NA	VCCAUX	C2
NA	VCCAUX	B14
NA	VCCINT	V18
NA	VCCINT	V14
NA	VCCINT	V10
NA	VCCINT	U17
NA	VCCINT	U16
NA	VCCINT	U15
NA	VCCINT	U14
NA	VCCINT	U13
NA	VCCINT	U12
NA	VCCINT	U11
NA	VCCINT	T17
NA	VCCINT	T11
NA	VCCINT	R17
NA	VCCINT	R11
NA	VCCINT	P18
NA	VCCINT	P17
NA	VCCINT	P11
NA	VCCINT	P10
NA	VCCINT	N17
NA	VCCINT	N11
NA	VCCINT	M17
NA	VCCINT	M11
NA	VCCINT	L17
NA	VCCINT	L16
NA	VCCINT	L15
NA	VCCINT	L14
NA	VCCINT	L13
NA	VCCINT	L12
NA	VCCINT	L11
NA	VCCINT	K18
NA	VCCINT	K14

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
NA	VCCINT	K10
NA	GND	AG27
NA	GND	AG26
NA	GND	AG14
NA	GND	AG2
NA	GND	AG1
NA	GND	AF27
NA	GND	AF26
NA	GND	AF20
NA	GND	AF8
NA	GND	AF2
NA	GND	AF1
NA	GND	AE25
NA	GND	AE3
NA	GND	AD24
NA	GND	AD14
NA	GND	AD4
NA	GND	AC23
NA	GND	AC17
NA	GND	AC11
NA	GND	AC5
NA	GND	AB22
NA	GND	AB6
NA	GND	AA21
NA	GND	AA7
NA	GND	Y26
NA	GND	Y20
NA	GND	Y8
NA	GND	Y2
NA	GND	W14
NA	GND	U23
NA	GND	U5
NA	GND	T16
NA	GND	T15
NA	GND	T14
NA	GND	T13

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
4	IO_L19N_4	AK6		
4	IO_L19P_4	AK5		
4	IO_L20N_4	AE9		
4	IO_L20P_4	AE10		
4	IO_L21N_4	AF7		
4	IO_L21P_4/VREF_4	AF8		
4	IO_L22N_4	AK7		
4	IO_L22P_4	AJ6		
4	IO_L23N_4	AD10		
4	IO_L23P_4	AD11		
4	IO_L24N_4	AG8		
4	IO_L24P_4	AG7		
4	IO_L49N_4	AJ8		
4	IO_L49P_4	AJ7		
4	IO_L50N_4	AE11		
4	IO_L50P_4	AE12		
4	IO_L51N_4	AG9		
4	IO_L51P_4/VREF_4	AG10		
4	IO_L52N_4	AK9		
4	IO_L52P_4	AJ9		
4	IO_L53N_4	AH8		
4	IO_L53P_4	AH9		
4	IO_L54N_4	AF11		
4	IO_L54P_4	AF10		
4	IO_L67N_4	AJ11	NC	
4	IO_L67P_4	AJ10	NC	
4	IO_L68N_4	AC12	NC	
4	IO_L68P_4	AC13	NC	
4	IO_L69N_4	AG11	NC	
4	IO_L69P_4/VREF_4	AG12	NC	
4	IO_L70N_4	AK11	NC	
4	IO_L70P_4	AK10	NC	
4	IO_L71N_4	AD12	NC	
4	IO_L71P_4	AD13	NC	
4	IO_L72N_4	AH12	NC	
4	IO_L72P_4	AH11	NC	
4	IO_L73N_4	AJ13	NC	NC

FF896 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

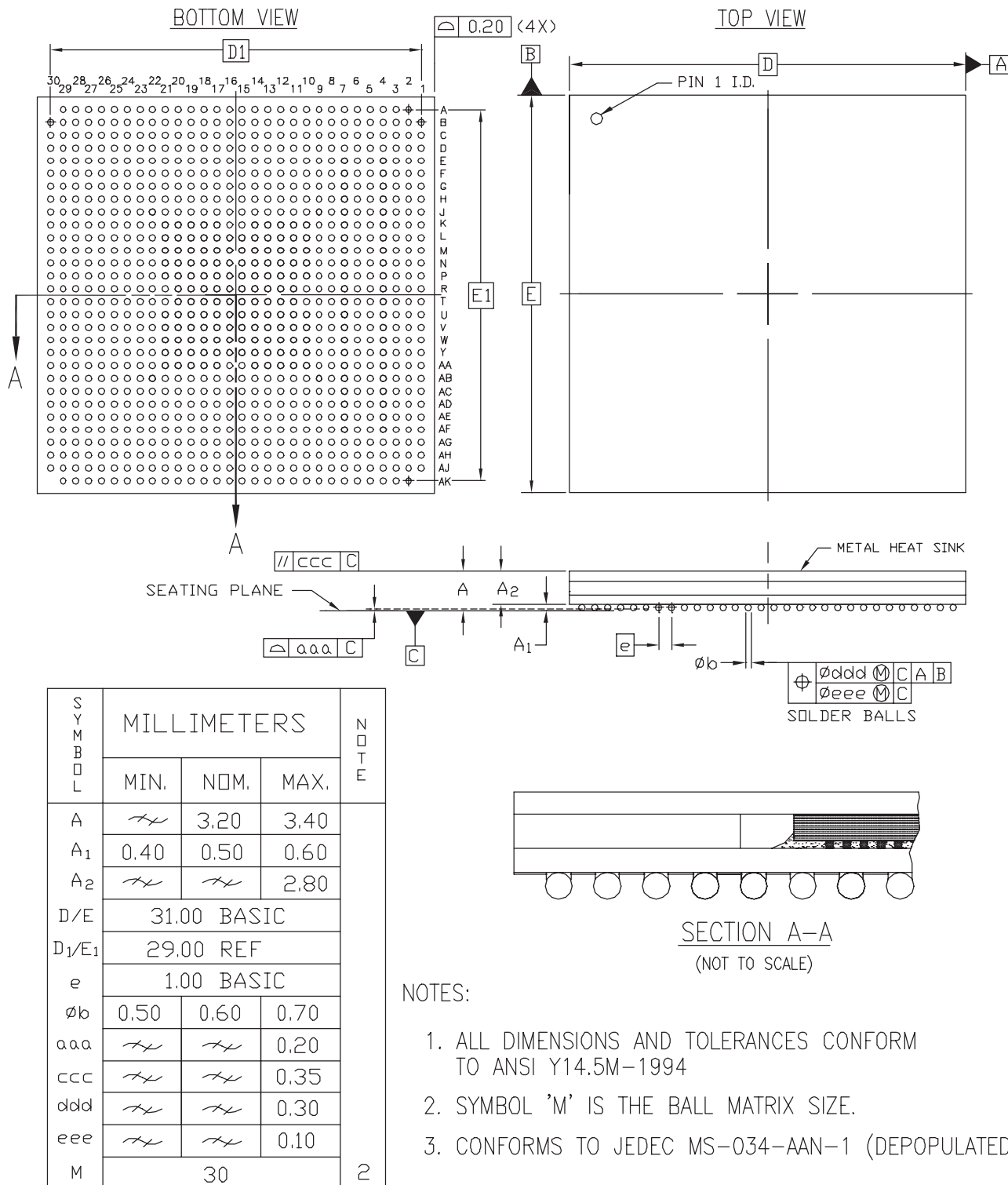


Figure 7: FF896 Flip-Chip Fine-Pitch BGA Package Specifications

FF1152 Flip-Chip Fine-Pitch BGA Package

As shown in Table 12, XC2V3000, XC2V4000, XC2V6000, and XC2V8000 Virtex-II devices are available in the FF1152 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the pin differences in the XC2V3000

FF1152 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

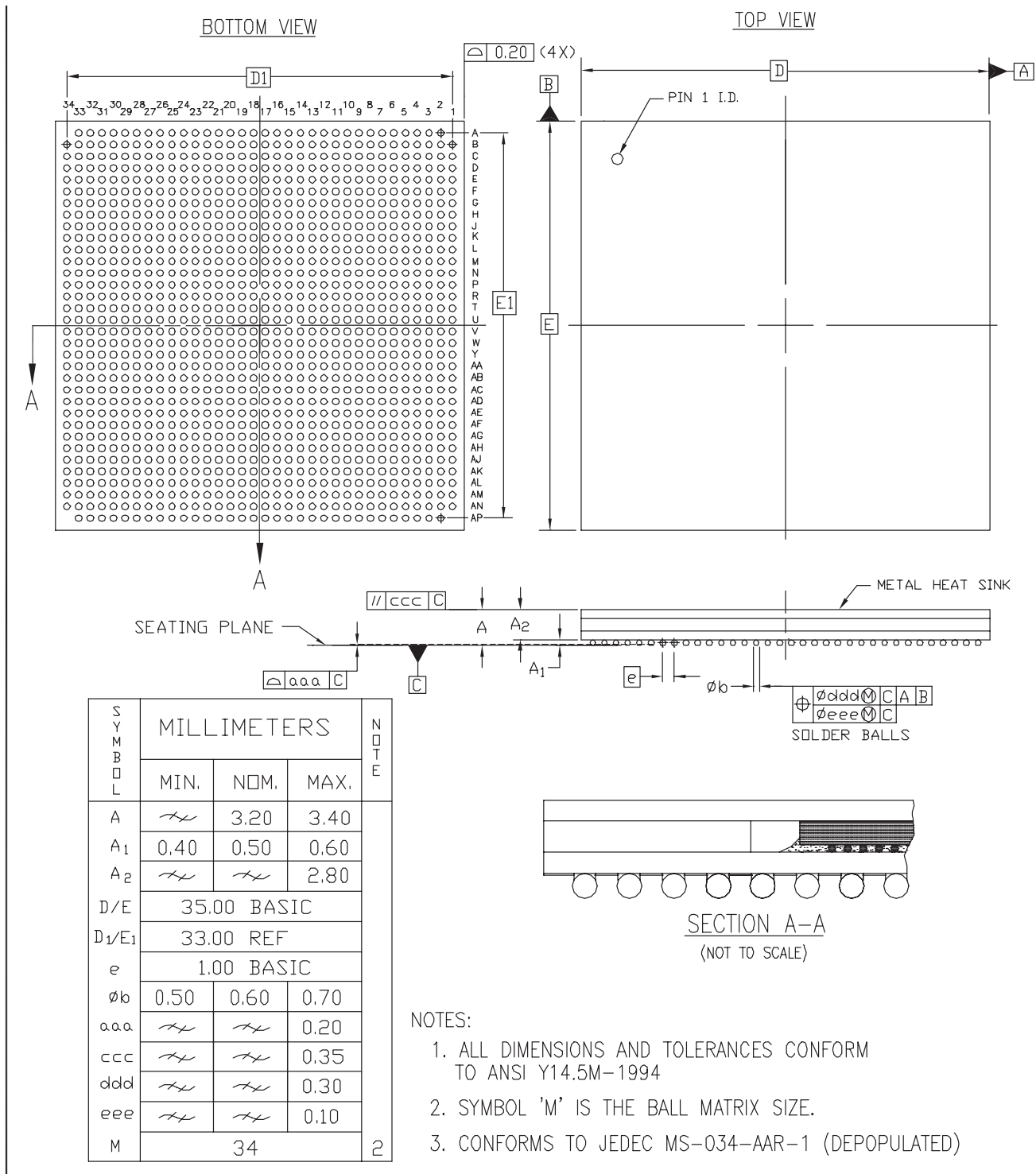


Figure 8: FF1152 Flip-Chip Fine-Pitch BGA Package Specifications

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L69N_1/VREF_1	E15		
1	IO_L69P_1	E16		
1	IO_L68N_1	K17		
1	IO_L68P_1	K16		
1	IO_L67N_1	C15		
1	IO_L67P_1	B15		
1	IO_L60N_1	F15		
1	IO_L60P_1	F16		
1	IO_L59N_1	H16		
1	IO_L59P_1	H15		
1	IO_L58N_1	C13		
1	IO_L58P_1	C14		
1	IO_L57N_1/VREF_1	D13		
1	IO_L57P_1	D14		
1	IO_L56N_1	M17		
1	IO_L56P_1	M16		
1	IO_L55N_1	A12		
1	IO_L55P_1	A13		
1	IO_L54N_1	B12		
1	IO_L54P_1	B13		
1	IO_L53N_1	G15		
1	IO_L53P_1	G14		
1	IO_L52N_1	C11		
1	IO_L52P_1	C12		
1	IO_L51N_1/VREF_1	F13		
1	IO_L51P_1	F14		
1	IO_L50N_1	L16		
1	IO_L50P_1	L15		
1	IO_L49N_1	A10		
1	IO_L49P_1	A11		
1	IO_L36N_1	E12	NC	
1	IO_L36P_1	E13	NC	
1	IO_L35N_1	K15	NC	
1	IO_L35P_1	J14	NC	
1	IO_L34N_1	B9	NC	
1	IO_L34P_1	B10	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
2	IO_L81P_2/VREF_2	U5		
2	IO_L82N_2	V2		
2	IO_L82P_2	U2		
2	IO_L83N_2	V8		
2	IO_L83P_2	W8		
2	IO_L84N_2	W7		
2	IO_L84P_2	V7		
2	IO_L91N_2	W1		
2	IO_L91P_2	V1		
2	IO_L92N_2	Y11		
2	IO_L92P_2	Y12		
2	IO_L93N_2	W4		
2	IO_L93P_2/VREF_2	V4		
2	IO_L94N_2	W2		
2	IO_L94P_2	W3		
2	IO_L95N_2	Y8		
2	IO_L95P_2	Y9		
2	IO_L96N_2	W5		
2	IO_L96P_2	W6		
3	IO_L96N_3	AB8		
3	IO_L96P_3	AA8		
3	IO_L95N_3	Y3		
3	IO_L95P_3	AA3		
3	IO_L94N_3	Y6		
3	IO_L94P_3	AA6		
3	IO_L93N_3/VREF_3	AB9		
3	IO_L93P_3	AA9		
3	IO_L92N_3	AA1		
3	IO_L92P_3	AB1		
3	IO_L91N_3	Y5		
3	IO_L91P_3	AA5		
3	IO_L84N_3	AB10		
3	IO_L84P_3	AA10		
3	IO_L83N_3	AA2		
3	IO_L83P_3	AB2		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L32P_4	AM14	NC	
4	IO_L33N_4	AT10	NC	
4	IO_L33P_4/VREF_4	AT9	NC	
4	IO_L34N_4	AV10	NC	
4	IO_L34P_4	AV9	NC	
4	IO_L35N_4	AH16	NC	
4	IO_L35P_4	AH17	NC	
4	IO_L36N_4	AP13	NC	
4	IO_L36P_4	AP12	NC	
4	IO_L49N_4	AU12		
4	IO_L49P_4	AU11		
4	IO_L50N_4	AK15		
4	IO_L50P_4	AJ16		
4	IO_L51N_4	AT12		
4	IO_L51P_4/VREF_4	AT11		
4	IO_L52N_4	AN15		
4	IO_L52P_4	AN14		
4	IO_L53N_4	AR12		
4	IO_L53P_4	AR13		
4	IO_L54N_4	AT14		
4	IO_L54P_4	AT13		
4	IO_L55N_4	AW11		
4	IO_L55P_4	AW10		
4	IO_L56N_4	AM15		
4	IO_L56P_4	AM16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AP14		
4	IO_L58N_4	AV13		
4	IO_L58P_4	AV12		
4	IO_L59N_4	AK16		
4	IO_L59P_4	AK17		
4	IO_L60N_4	AR16		
4	IO_L60P_4	AR15		
4	IO_L67N_4	AW13		
4	IO_L67P_4	AW12		
4	IO_L68N_4	AL16		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L50P_7	P32		
7	IO_L50N_7	N32		
7	IO_L49P_7	L37		
7	IO_L49N_7	M37		
7	IO_L48P_7	N34		
7	IO_L48N_7	P34		
7	IO_L47P_7	P31		
7	IO_L47N_7	N31		
7	IO_L46P_7	M35		
7	IO_L46N_7	N35		
7	IO_L45P_7/VREF_7	L36		
7	IO_L45N_7	M36		
7	IO_L44P_7	R28		
7	IO_L44N_7	P28		
7	IO_L43P_7	K39		
7	IO_L43N_7	L39		
7	IO_L36P_7	L34	NC	
7	IO_L36N_7	M34	NC	
7	IO_L35P_7	P29	NC	
7	IO_L35N_7	N29	NC	
7	IO_L34P_7	J38	NC	
7	IO_L34N_7	K38	NC	
7	IO_L33P_7/VREF_7	L33	NC	
7	IO_L33N_7	M33	NC	
7	IO_L32P_7	M32	NC	
7	IO_L32N_7	L32	NC	
7	IO_L31P_7	H39	NC	
7	IO_L31N_7	J39	NC	
7	IO_L30P_7	J36		
7	IO_L30N_7	K36		
7	IO_L29P_7	N30		
7	IO_L29N_7	M30		
7	IO_L28P_7	J37		
7	IO_L28N_7	K37		
7	IO_L27P_7/VREF_7	J35		
7	IO_L27N_7	K35		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	Y17		
NA	GND	Y16		
NA	GND	Y10		
NA	GND	Y7		
NA	GND	Y4		
NA	GND	Y1		
NA	GND	W24		
NA	GND	W23		
NA	GND	W22		
NA	GND	W21		
NA	GND	W20		
NA	GND	W19		
NA	GND	W18		
NA	GND	W17		
NA	GND	W16		
NA	GND	V24		
NA	GND	V23		
NA	GND	V22		
NA	GND	V21		
NA	GND	V20		
NA	GND	V19		
NA	GND	V18		
NA	GND	V17		
NA	GND	V16		
NA	GND	U36		
NA	GND	U32		
NA	GND	U24		
NA	GND	U23		
NA	GND	U22		
NA	GND	U21		
NA	GND	U20		
NA	GND	U19		
NA	GND	U18		
NA	GND	U17		
NA	GND	U16		
NA	GND	U8		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
7	IO_L96N_7	R27	
7	IO_L95P_7	R24	
7	IO_L95N_7	N24	
7	IO_L94P_7	T29	
7	IO_L94N_7	R29	
7	IO_L93P_7/VREF_7	R31	
7	IO_L93N_7	P31	
7	IO_L92P_7	R26	
7	IO_L92N_7	P26	
7	IO_L91P_7	R30	
7	IO_L91N_7	P30	
7	IO_L78P_7	R25	
7	IO_L78N_7	P25	
7	IO_L77P_7	R28	
7	IO_L77N_7	P28	
7	IO_L76P_7	N31	
7	IO_L76N_7	M31	
7	IO_L75P_7/VREF_7	R23	
7	IO_L75N_7	P23	
7	IO_L74P_7	N30	
7	IO_L74N_7	M30	
7	IO_L73P_7	P27	
7	IO_L73N_7	N27	
7	IO_L72P_7	P22	
7	IO_L72N_7	N22	
7	IO_L71P_7	N29	
7	IO_L71N_7	M29	
7	IO_L70P_7	N28	
7	IO_L70N_7	M28	
7	IO_L69P_7/VREF_7	N26	
7	IO_L69N_7	M26	
7	IO_L68P_7	L31	
7	IO_L68N_7	K31	
7	IO_L67P_7	M27	
7	IO_L67N_7	L27	
7	IO_L54P_7	N23	
7	IO_L54N_7	M23	
7	IO_L53P_7	L30	